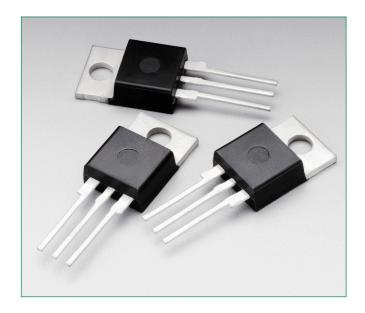


Surface Mount -50 - 800V > 2N6504 Series

2N6504 Series





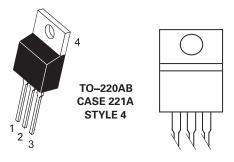
Description

Designed primarily for half-wave ac control applications, such as motor controls, heating controls and power supply crowbar circuits.

Features

- Glass Passivated Junctions for Greater Parameter Uniformity and Stability
- Small, Rugged, Thermowatt Construction for Low Thermal Resistance, High Heat Dissipation and Durability
- Blocking Voltage to 800 Volts
- 300 A Surge Current Capability
- Pb-Free Package is Available

Pin Out



Functional Diagram



Additional Information





Samples

Maximum Ratings $(T_1 = 25^{\circ}C \text{ unless otherwise noted})$

| Rating | Symbol | Value | Unit |
|---|--|--------------------------------|------|
| Peak Repetitive Off-State Voltage (Note 1) (Gate Open, Sine Wave 50 to 60 Hz, T_J = 25 to 125°C) 2N6504 2N6505 2N6507 2N6508 2N6509 | V _{drm} , V _{rrm} | 50 100 400 600 800 | V |
| On-State RMS Current (180° Conduction Angles; $T_c = 85$ °C) | I _{T (RMS)} | 25 | А |
| Average On-State Current (180° Conduction Angles; $T_c = 85$ °C) | I _{T (AV)} | 16 | А |
| Peak Non-repetitive Surge Current (1/2 Cycle, Sine Wave 60 Hz, T _J = 100°C) | I _{TSM} | 250 | A²s |
| Forward Peak Gate Power (Pulse Width ≤ 1.0 µs, T _C = 85°C) | P _{GM} | 20 | W |
| Forward Average Gate Power (t = 8.3 ms , $T_c = 85^{\circ}\text{C}$) | P _{G(AV)} | 0.5 | W |
| Forward Peak Gate Current (Pulse Width ≤ 1.0 µs, T _C = 85°C) | I _{GM} | 2.0 | А |
| Operating Junction Temperature Range | T _J | -40 to +125 | °C |
| Storage Temperature Range | T _{stg} | -40 to +125 | °C |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Thermal Characteristics

| Rating | Symbol | Value | Unit |
|---|------------------|-------|------|
| *Thermal Resistance, Junction to Case | R _{sJC} | 1.5 | °C/W |
| *Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds | T _L | 260 | °C |

^{*} Indicates JEDEC Registered Data..

^{1.} V_{DBM} and V_{BBM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

Thyristors

Electrical Characteristics - **OFF** (T_C = 25°C unless otherwise noted)

| Characteristic | | Symbol | Min | Тур | Max | Unit |
|---|----------------------------------|--------------------|-----|-----|-----|------|
| †Peak Repetitive Blocking Current | $T_{_{\rm J}}=25^{\circ}{\rm C}$ | I _{DRM} , | - | - | 1.0 | μΑ |
| $(V_{AK} = V_{DRM} = V_{RRM}; Gate Open)$ | T _J = 125°C | I _{RRM} | - | - | 2.0 | mA |

Electrical Characteristics - ON (T_c = 25°C unless otherwise noted; Electricals apply in both directions)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|-----------------|-----|-----|-----|-------|
| * Forward On-State Voltage (Note 2) (ITM = 50 A) | V _{TM} | _ | _ | 1.8 | V |
| * Gate Trigger Current (Continuous dc) $T_c = 25^{\circ}C$ | | _ | 9.0 | 30 | mA |
| $(V_{AK} = Rated V_{DRM} or V_{RRM'} Gate Open)$ $T_{C} = -40 ^{\circ}C$ | GT | _ | - | 75 | IIIA |
| * Gate Trigger Voltage (Continuous dc) ($V_{AK} = 12 \text{ Vdc}, R_L = 100 \Omega, T_C = -40 ^{\circ}\text{C}$) | V _{GT} | _ | 1.0 | 1.5 | V |
| Gate Non-Trigger Voltage ($V_{AK} = 12 \text{ Vdc}, R_L = 100 \Omega, T_J = 125^{\circ}\text{C}$) | V _{GD} | 0.2 | _ | _ | V |
| *Holding Current ($V_D = 12 \text{ Vdc}$, $T_C = 25^{\circ}\text{C}$ | | _ | 18 | 40 | Λ |
| *Holding Current (V_D = 12 Vdc, T_C = 25°C Initiating Current = 200 mA, Gate Open) T_C = -40 °C | I _H | _ | - | 80 | mA mA |
| * Turn-On Time ($I_{TM} = 25 \text{ A}, I_{GT} = 50 \text{ mAdc}$) | t _{gt} | _ | 1.5 | 2.0 | μs |
| Turn-Off Time (V_{RM} = rated voltage) (I_{TM} = 25 A, I_{R} = 25 A) | + | - | - | 15 | 116 |
| $(I_{TM} = 25 \text{ A}, I_{R} = 25 \text{ A}, T_{J} = 125^{\circ}\text{C})$ | t _q | - | - | 35 | μs |

^{*}Indicates JEDEC Registered Data

Dynamic Characteristics

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|----------|-----|-----|-----|------|
| Critical Rate of Rise of Off State Voltage (Gate Open, Rated VDRM, Exponential Waveform) | dv/dt(c) | _ | 50 | - | V/µs |

^{2.} Pulse Test: Pulse Width $\leq 300~\mu sec$, Duty Cycle $\leq 2\,\%$.



Voltage Current Characteristic of SCR

| Symbol | Parameter | |
|------------------|--|--|
| V_{DRM} | Peak Repetitive Forward Off State Voltage | |
| I _{DRM} | Peak Forward Blocking Current | |
| V _{RRM} | Peak Repetitive Reverse Off State Voltage | |
| I _{RRM} | I _{RRM} Peak Reverse Blocking Current | |
| V _{TM} | Maximum On State Voltage | |
| I _H | Holding Current | |

Thyristors

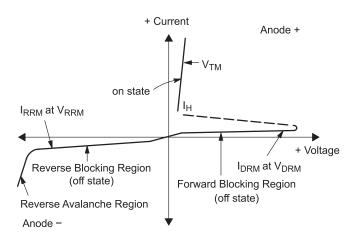


Figure 1. AverageCurrent Derating

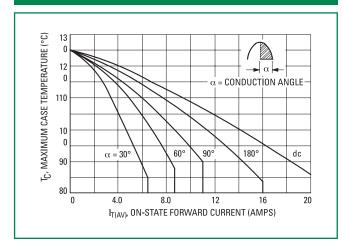


Figure 2. Maximum On-State Power Dissipation

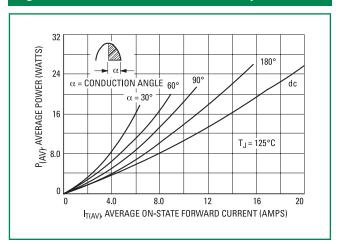




Figure 3. Typical On-State Characteristics

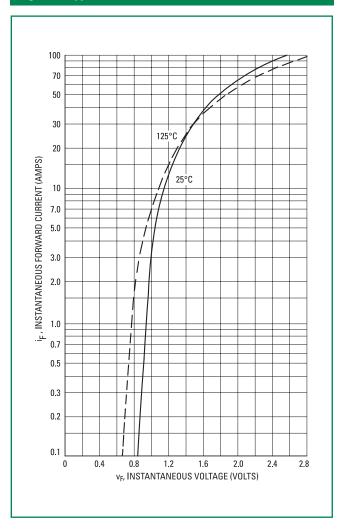


Figure 4. Maximum Non-Repetitive Surge Current

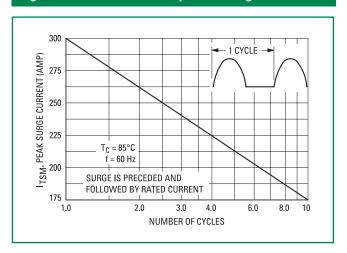
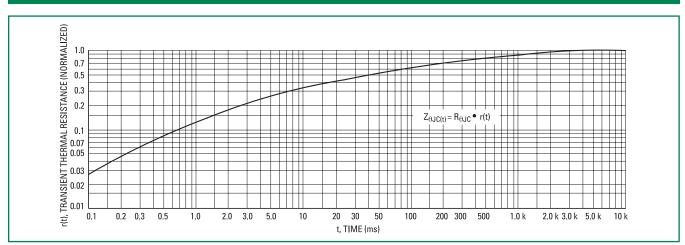


Figure 5. Thermal Response



Typical Trigger Characteristics

Figure 6. Typical Gate Trigger Current vs. Junction Temperature

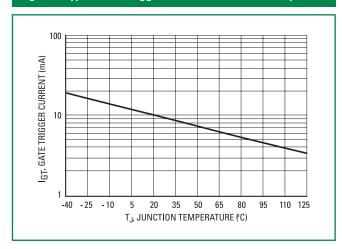


Figure 8. Typical Holding Current vs. Junction Temperature

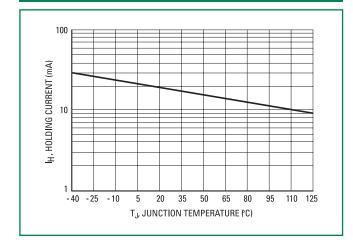
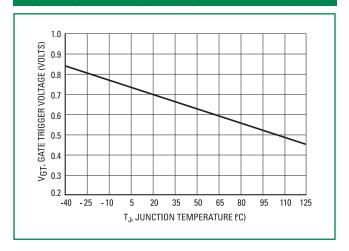


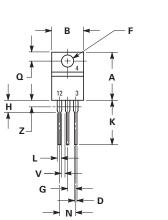
Figure 7. Typical Gate Trigger Voltage vs. Junction Temperature

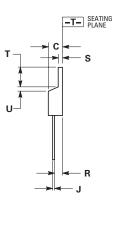


Ordering Information

| Device | Package | Shipping |
|----------|-----------------------|------------------|
| 2N6504 | TO-220AB | |
| 2N6504G | TO-220AB (Pb-Free) | 500 Units / Box |
| 2N6505 | TO-220AB | 300 Offits / Box |
| 2N6505G | TO-220AB (Pb-Free) | |
| 2N6505T | TO-220AB | FO Heite / Dec |
| 2N6505TG | TO-220AB (Pb-Free) | 50 Units / Box |
| 2N6507 | TO-220AB | 500 Hz'tz / Day |
| 2N6507G | TO-220AB (Pb-Free) | 500 Units / Box |
| 2N6507T | TO-220AB | 50 H :: / B |
| 2N6507TG | TO-220AB (Pb-Free) | 50 Units / Box |
| 2N6508 | TO-220AB | 50011 : |
| 2N6508G | TO-220AB (Pb-Free) | 500 Units / Box |
| 2N6508TG | TO-220AB | 50 Units / Box |
| 2N6509 | TO-220AB (Pb-Free) | 500 Units / Box |
| 2N6509G | TO-220AB | 300 Offits / Box |
| 2N6509T | TO-220AB (Pb-Free) | 50 Units / Box |
| 2N6509TG | TO-220AB | 30 011113 / 150X |

Dimensions

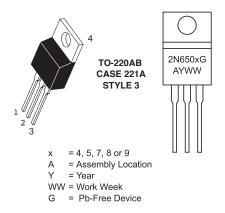




| | Inches | | Millim | neters |
|-----|--------|-------|--------|--------|
| Dim | Min | Max | Min | Max |
| А | 0.570 | 0.620 | 14.48 | 15.75 |
| В | 0.380 | 0.405 | 9.66 | 10.28 |
| С | 0.160 | 0.190 | 4.07 | 4.82 |
| D | 0.025 | 0.035 | 0.64 | 0.88 |
| F | 0.142 | 0.147 | 3.61 | 3.73 |
| G | 0.095 | 0.105 | 2.42 | 2.66 |
| Н | 0.110 | 0.155 | 2.80 | 3.93 |
| J | 0.014 | 0.022 | 0.36 | 0.55 |
| K | 0.500 | 0.562 | 12.70 | 14.27 |
| L | 0.045 | 0.060 | 1.15 | 1.52 |
| N | 0.190 | 0.210 | 4.83 | 5.33 |
| Q | 0.100 | 0.120 | 2.54 | 3.04 |
| R | 0.080 | 0.110 | 2.04 | 2.79 |
| S | 0.045 | 0.055 | 1.15 | 1.39 |
| Т | 0.235 | 0.255 | 5.97 | 6.47 |
| U | 0.000 | 0.050 | 0.00 | 1.27 |
| V | 0.045 | | 1.15 | |
| Z | | 0.080 | | 2.04 |

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.
- 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

Part Marking System



| Pin Assignment | |
|----------------|---------|
| 1 | Cathode |
| 2 | Anode |
| 3 | Gate |
| 4 | Anode |

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